

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-case thermal resistance	R _{eJC}	2	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 7.5A, T_J = 25^{\circ}C$	VF	0.64	0.68	V
	$I_F = 15.0A, T_J = 25^{\circ}C$		0.76	0.80	V
	I _F = 7.5A, T _J = 125°C		0.55	0.60	V
	$I_F = 15.0A, T_J = 125^{\circ}C$		0.67	0.70	V
Reverse current @ rated V _R per diode ⁽²⁾	$T_J = 25^{\circ}C$	- I _R	-	30	μA
	T _J = 125°C		-	10	mA

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
MBRS15H45CT	TO-263AB (D ² PAK)	800 / Tape & Reel	



1000

100

10

1

0.1

0.01

10 20 30 40 50 60

INSTANTANEOUS REVERSE CURRENT (µA)

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

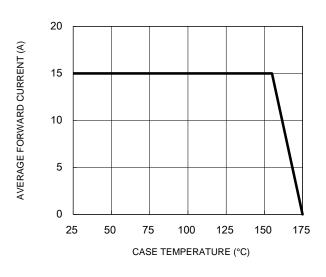


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

T_J=125[°]C

T_J=25°C

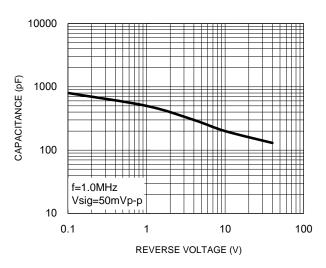
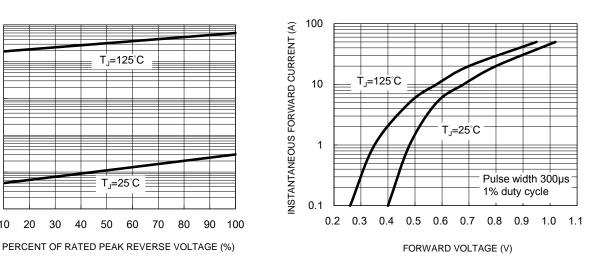


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



180 PEAK FORWARD SURGE CURRENT (A) 8.3ms single half sine wave 150 120 90 60 30 0 1 10 100 NUMBER OF CYCLES AT 60 Hz

Fig.5 Maximum Non-Repetitive Forward Surge Current

Version: H2103



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

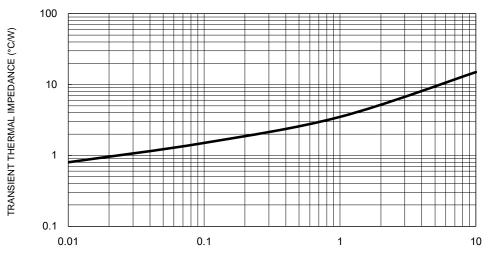


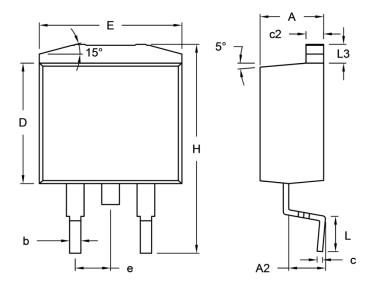
Fig.6 Typical Transient Thermal Impedance

PULSE DURATION (s)

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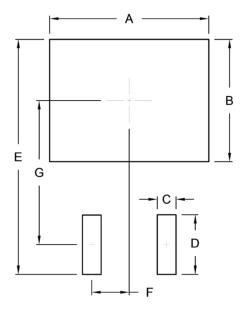
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



DIM.	Unit (mm)		Unit ((inch)	
	Min.	Max.	Min.	Max.	
A	4.44	4.70	0.175	0.185	
A2	2.03	2.79	0.080	0.110	
b	0.68	0.94	0.027	0.037	
с	0.36	0.53	0.014	0.021	
c2	1.14	1.40	0.045	0.055	
D	8.25	9.25	0.325	0.364	
E	-	10.50	-	0.413	
е	2.41	2.67	0.095	0.105	
н	14.60	15.88	0.575	0.625	
L	2.29	2.79	0.090	0.110	
L3	1.14	1.40	0.045	0.055	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	10.80	0.425
В	8.30	0.327
С	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

MARKING DIAGRAM



P/N	= Marking Code
G	= Green Compound
YWW	= Date Code
F	= Factory Code



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